

NSS20200LT1G, NSV20200LT1G

20 V, 4.0 A, Low $V_{CE(sat)}$ PNP Transistor

ON Semiconductor's e²PowerEdge family of low $V_{CE(sat)}$ transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

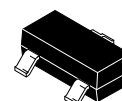
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



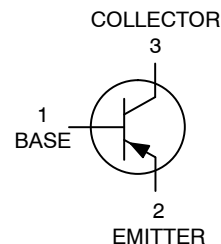
ON Semiconductor®

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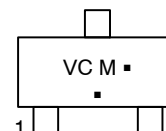
-20 VOLTS
4.0 AMPS
PNP LOW $V_{CE(sat)}$ TRANSISTOR
EQUIVALENT $R_{DS(on)}$ 65 m Ω



SOT-23 (TO-236)
CASE 318
STYLE 6



MARKING DIAGRAM



VC = Specific Device Code
M = Date Code*
▪ = Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|---------------------|------------------------|
| NSS20200LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |
| NSV20200LT1G | SOT-23 (Pb-Free) | 3,000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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MAXIMUM RATINGS (T_A = 25°C)

| Rating | Symbol | Max | Unit |
|--------------------------------|------------------|----------------------------|------|
| Collector-Emitter Voltage | V _{CEO} | -20 | Vdc |
| Collector-Base Voltage | V _{CBO} | -20 | Vdc |
| Emitter-Base Voltage | V _{EBO} | -7.0 | Vdc |
| Collector Current – Continuous | I _C | -2.0 | A |
| Collector Current – Peak | I _{CM} | -4.0 | A |
| Electrostatic Discharge | ESD | HBM Class 3B MM Class C | |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|-----------------------------------|-------------|-------------|
| Total Device Dissipation T _A = 25°C Derate above 25°C | P _D (Note 1) | 460 3.7 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | R _{θJA} (Note 1) | 270 | °C/W |
| Total Device Dissipation T _A = 25°C Derate above 25°C | P _D (Note 2) | 540 4.3 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | R _{θJA} (Note 2) | 230 | °C/W |
| Total Device Dissipation (Single Pulse < 10 sec.) | P _{Dsingle} (Note 3) | 710 | mW |
| Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 @ 100 mm², 1 oz. copper traces.
2. FR-4 @ 500 mm², 1 oz. copper traces.
3. Thermal response.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

OFF CHARACTERISTICS

| | | | | | |
|--|----------------------|------|---|------|------|
| Collector – Emitter Breakdown Voltage (I _C = -10 mA, I _B = 0) | V _{(BR)CEO} | -20 | - | - | Vdc |
| Collector – Base Breakdown Voltage (I _C = -0.1 mA, I _E = 0) | V _{(BR)CBO} | -20 | - | - | Vdc |
| Emitter – Base Breakdown Voltage (I _E = -0.1 mA, I _C = 0) | V _{(BR)EBO} | -7.0 | - | - | Vdc |
| Collector Cutoff Current (V _{CB} = -20 Vdc, I _E = 0) | I _{CBO} | - | - | -0.1 | μAdc |
| Emitter Cutoff Current (V _{EB} = -7.0 Vdc) | I _{EBO} | - | - | -0.1 | μAdc |

ON CHARACTERISTICS

| | | | | | |
|--|----------------------|--------------------------|--------------------------------------|--------------------------------------|-----|
| DC Current Gain (Note 4) (I _C = -10 mA, V _{CE} = -2.0 V) (I _C = -500 mA, V _{CE} = -2.0 V) (I _C = -1.0 A, V _{CE} = -2.0 V) (I _C = -2.0 A, V _{CE} = -2.0 V) | h _{FE} | 250 250 180 150 | - 300 - - | - - - - | |
| Collector – Emitter Saturation Voltage (Note 4) (I _C = -0.1 A, I _B = -0.010 A) (Note 5) (I _C = -1.0 A, I _B = -0.100 A) (I _C = -1.0 A, I _B = -0.010 A) (I _C = -2.0 A, I _B = -0.200 A) | V _{CE(sat)} | - - - - | -0.008 -0.065 -0.100 -0.130 | -0.013 -0.090 -0.120 -0.180 | V |
| Base – Emitter Saturation Voltage (Note 4) (I _C = -1.0 A, I _B = -0.01 A) | V _{BE(sat)} | - | - | -0.900 | V |
| Base – Emitter Turn-on Voltage (Note 4) (I _C = -1.0 A, V _{CE} = -2.0 V) | V _{BE(on)} | - | - | -0.900 | V |
| Cutoff Frequency (I _C = -100 mA, V _{CE} = -5.0 V, f = 100 MHz) | f _T | 100 | - | - | MHz |
| Input Capacitance (V _{EB} = 0.5 V, f = 1.0 MHz) | C _{ibo} | - | - | 330 | pF |
| Output Capacitance (V _{CB} = 3.0 V, f = 1.0 MHz) | C _{obo} | - | - | 100 | pF |

SWITCHING CHARACTERISTICS

| | | | | | |
|---|----------------|---|---|-----|----|
| Delay (V _{CC} = -15 V, I _C = 750 mA, I _{B1} = 15 mA) | t _d | - | - | 60 | ns |
| Rise (V _{CC} = -15 V, I _C = 750 mA, I _{B1} = 15 mA) | t _r | - | - | 120 | ns |
| Storage (V _{CC} = -15 V, I _C = 750 mA, I _{B1} = 15 mA) | t _s | - | - | 300 | ns |
| Fall (V _{CC} = -15 V, I _C = 750 mA, I _{B1} = 15 mA) | t _f | - | - | 130 | ns |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle ≤ 2%.
5. Guaranteed by design but not tested.

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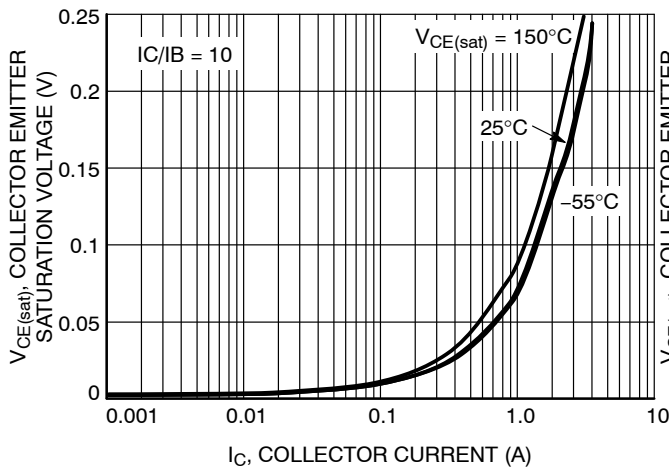


Figure 1. Collector Emitter Saturation Voltage vs. Collector Current

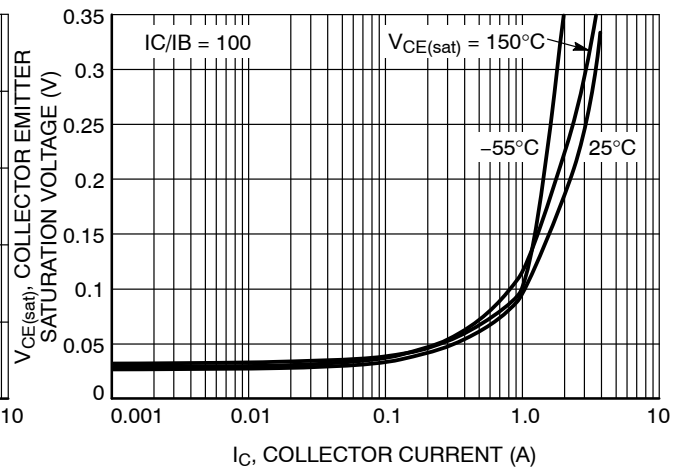


Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

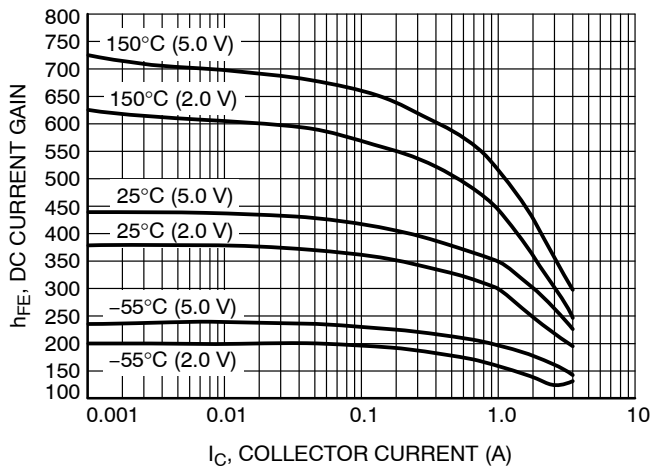


Figure 3. DC Current Gain vs. Collector Current

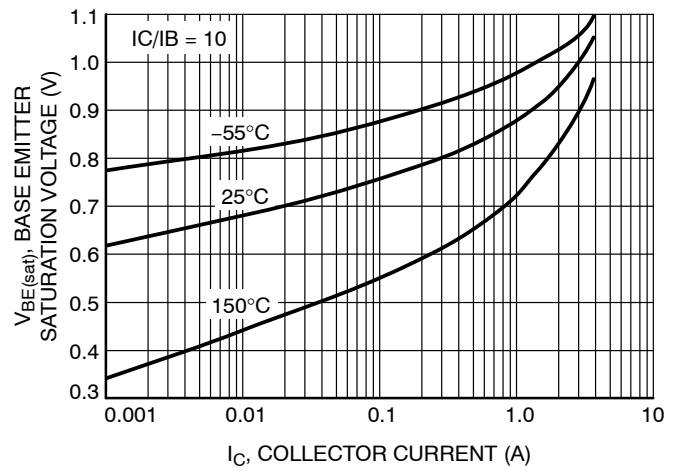


Figure 4. Base Emitter Saturation Voltage vs. Collector Current

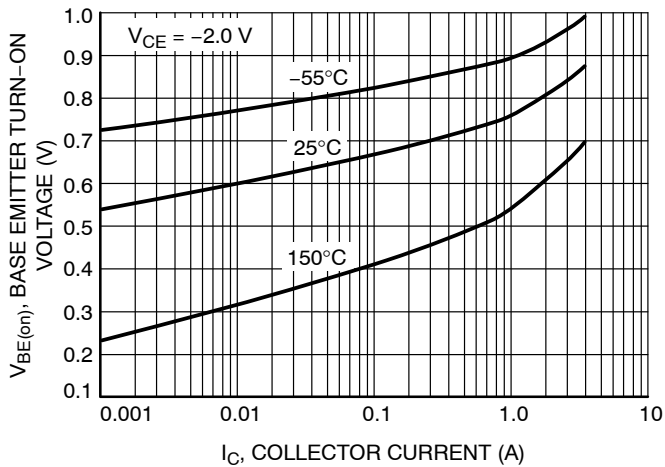


Figure 5. Base Emitter Turn-On Voltage vs. Collector Current

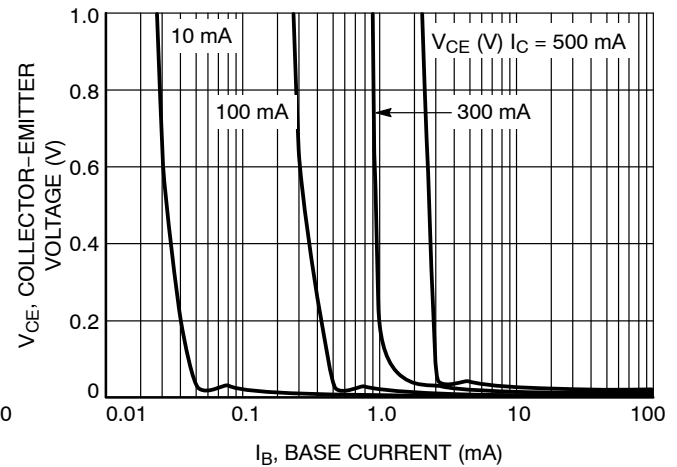


Figure 6. Saturation Region

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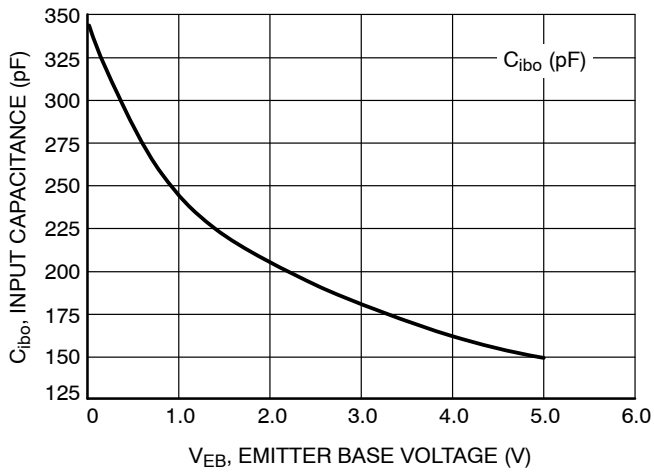


Figure 7. Input Capacitance

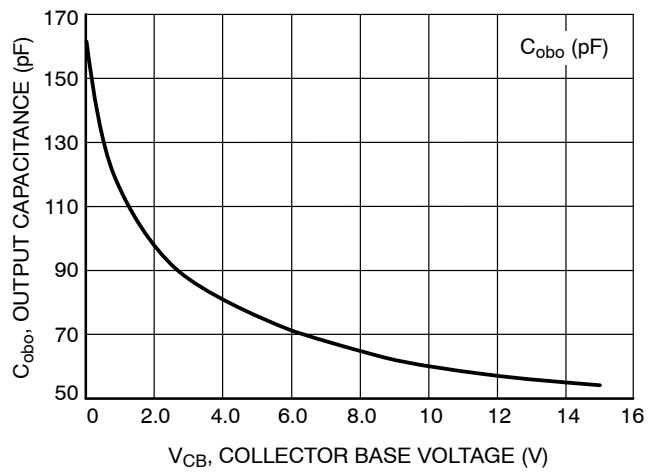


Figure 8. Output Capacitance

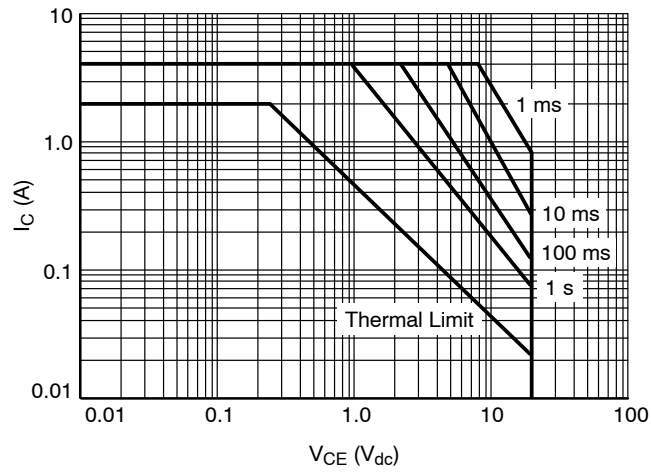
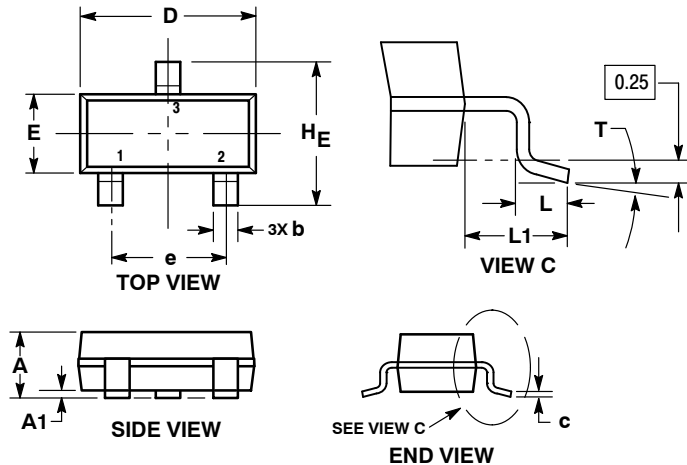


Figure 9. Safe Operating Area

NSS20200LT1G, NSV20200LT1G

PACKAGE DIMENSIONS

SOT-23 (TO-236)
CASE 318-08
ISSUE AR



NOTES:

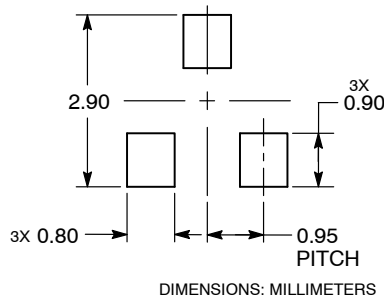
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| c | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| L | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| T | 0° | --- | 10° | 0° | --- | 10° |

STYLE 6:

1. BASE
2. EMITTER
3. COLLECTOR

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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